TIL194, TIL195, TIL196, TIL194A, TIL195A, TIL196A TIL194B, TIL195B, TIL196B AC-INPUT OPTOCOUPLERS

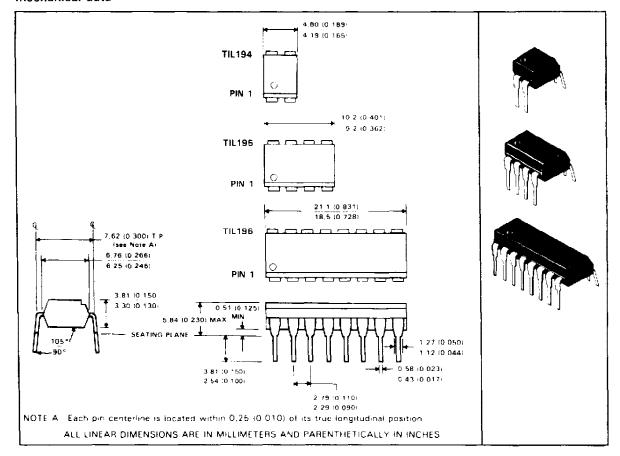
SOES001 D3287 MAY 1989 - REVISED SEPTEMBER 1989

- AC Signal Input
- Gallium-Arsenide Diode Infrared Source
- Source Is Optically Coupled to Silicon N-P-N Phototransistor
- Choice of One, Two, or Four Channels
- Choice of Three Current-Transfer Ratios
- High-Voltage Electrical Isolation 3.535 kV Peak (2.5 kV rms)
- Plastic Dual-In-Line Packages
- UL Listed File #E65085

description

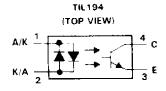
These optocouplers consist of two gallium-arsenide light-emitting diodes connected in a reverse-parallel configuration for ac-input applications and a silicon n-p-n phototransistor per channel. The TII 194 has one channel in a 4-pin package, the TIL195 has two channels in an 8-pin package, and the TIL196 has four channels in a 16-pin package. The standard devices, TIL194, TIL195, and TIL196, are tested for a current-transfer ratio of 20% minimum. Devices selected for a current-transfer ratio of 50% and 100% minimum are designated with the suffix A and B respectively.

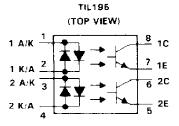
mechanical data

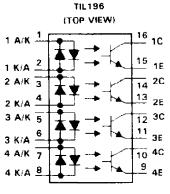


TIL194, TIL195, TIL196, TIL194A, TIL195A, TIL196A TIL194B, TIL195B, TIL196B AC-INPUT OPTOCOUPLERS

schematic diagrams







absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

| Input-to-output voltage (see Note 1) |
|--|
| Emitter-collector voltage |
| Input diode continuous forward current at (or below) 25°C free-air temperature |
| (see Note 3) |
| Continuous power dissipation at (or below) 25 °C free-air temperature: |
| Phototransistor (see Note 4) |
| Input diode plus phototransistor per channel (see Note 5) |
| Storage temperature range55°C to 125°C |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds |

- NOTES: 1. This rating applies for sine wave operation at 50 or 60 Hz. Service capability is verified by testing in accordance with UL requirements.
 - 2. This value applies when the base-emitter diode is open circuited.
 - 3. Denate linearly to 100 $^{\rm o}{\rm C}$ free air temperature at the rate of 0.67 mA/ $^{\rm o}{\rm C}$
 - 4. Denate linearly to 100°C free air temperature at the rate of 2 mW/°C.
 - 5. Derate linearly to 100°C free air temperature at the rate of 2.67 mW/°C.

electrical characteristics at 25 °C free-air temperature (unless otherwise noted)

| PARAMETER | | | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|---------------------|--------------------------------------|------------------------------|--|-----------|------|------------------|-----|------|
| V(BR)CEO | Collector-emitter breakdown voltage | | IC = 0.5 mA | IF = 0 | 35 | | | V |
| V(BR)ECO | Emitter-collector breakdown voltage | | IC = 100 μA, | IF = 0 | 7 | | | V |
| ^I C(aff) | Off-state coll | ector current | V _{CE} = 24 V, | IF = O | | | 100 | nΑ |
| CTR [†] | Current transfer ratio | TIL194, TIL195, TIL196 | l _F = 5 mA, | VCE = 5 V | 20% | | | |
| | | TIL194A, TIL195A, TIL196A | | | 50% | | | |
| | | TIL194B, TIL195B, TIL196B | | | 100% | | | |
| VF [†] | Input diode static forward voltage | | IF = 20 mA | | | | 1.4 | V |
| VCE(sat) † | Collector-emitter saturation voltage | | IF = 5 mA, | Ic = 1 mA | | | 0.4 | V |
| C _{io} | Input-to-output capacitance | | V _{in-out} = 0, See Note 6 | f = 1 MH2 | | 1 | | рF |
| rio | Input-to-output internal resistance | | V _{in-out} = ±1 kV. See Note 6 | | | 10 ¹¹ | | Ω |
| IC(an)1 IC(an)2 | On-state colli (see Note 7) | ector current symmetry ratio | V _{CE} = 5 V. | IF = 5 mA | 1 | | 3 | |

[†]These parameters apply to either direction of the input current.

NOTES 6: These parameters are measured between all input-diode leads shorted together and all phototransistor leads shorted together

7. The higher of the two values of I_{Clon} generated by the two diodes is taken as I_{Clon} .



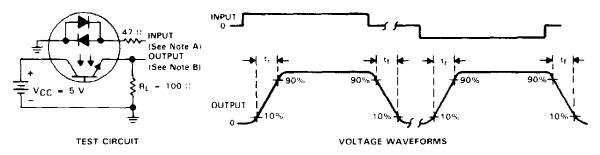
switching characteristics at 25 °C free-air temperature

| | PARAMETER | TEST CONDITIONS | TYP | UNIT |
|-----------------------------|-----------|------------------------------------|-----|------|
| t, † | Rise time | VCC = 5 V. IC(on) = 2 mA, | 6 | jıS |
| 1 _f [†] | Fall time | R _L 100 Ω, See Figure 1 | 6 | μ5 |

^{*}These parameters apply to either direction of the input current.

PARAMETER MEASUREMENT INFORMATION

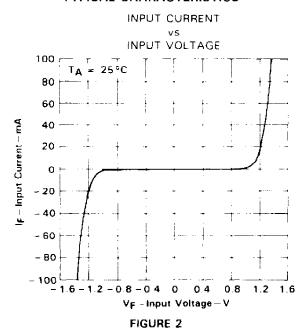
Adjust amplitude of input pulse for IC(on) = 2 mA



NOTES: A The imput waveform is supplied by a generator with the following characteristics: $Z_0 \sim 50~\Omega_c t_f \leq 15~ns$, duty cycle = 1% B. The output waveform is monitored on an oscilloscope with the following characteristics: $t_f \leq 12~ns$; $R_i \geq 1~M\Omega/C_i \leq 20~pF$.

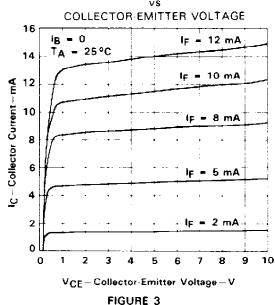
FIGURE 1. SWITCHING TIMES

TYPICAL CHARACTERISTICS

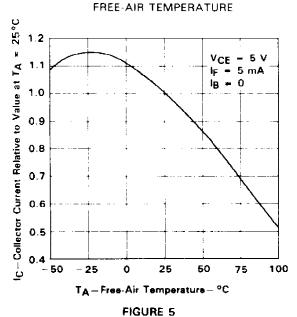


TYPICAL CHARACTERISTICS

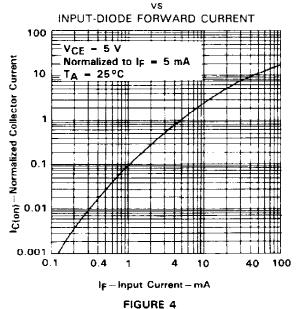
TIL194, TIL195, TIL196 COLLECTOR CURRENT



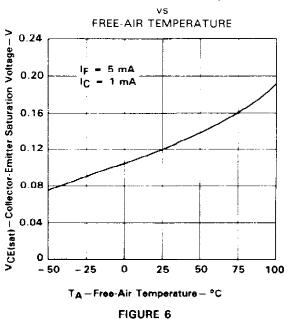
RELATIVE ON-STATE COLLECTOR CURRENT vs



NORMALIZED ON-STATE COLLECTOR CURRENT



TYPICAL COLLECTOR-EMITTER SATURATION VOLTAGE



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